Dual Input Standalone Li-Ion Battery Charger

FEATURES

- **Charges Single-Cell Li-Ion Batteries from Wall Adapter and USB Inputs**
- **Automatic Input Power Detection and Selection**
- **Charge Current Programmable up to 950mA from Wall Adapter Input**
- **C/X Charge Current Termination**
- Thermal Regulation Maximizes Charge Rate Without Risk of Overheating*
- Preset Charge Voltage with ±0.6% Accuracy
- 18µA USB Suspend Current in Shutdown
- Power Present Status Output
- Charge Status Output
- Automatic Recharge
- Available in a Thermally Enhanced, Low Profile (0.75mm) 10-Lead (3mm × 3mm) DFN Package

APPLICATIONS

- Cellular Telephones
- Handheld Computers
- Portable MP3 Players
- Digital Cameras

DESCRIPTION

The LTC®4076 is a standalone linear charger that is capable of charging a single-cell Li-Ion battery from both wall adapter and USB inputs. The charger can detect power at the inputs and automatically select the appropriate power source for charging.

No external sense resistor or blocking diode is required for charging due to the internal MOSFET architecture. Internal thermal feedback regulates the battery charge current to maintain a constant die temperature during high power operation or high ambient temperature conditions. The float voltage is fixed at 4.2V and the charge current is programmed with an external resistor. The LTC4076 terminates the charge cycle when the charge current drops below the user programmed termination threshold after the final float voltage is reached. The LTC4076 can be put into shutdown mode reducing the DCIN supply current to 20µA, the USBIN supply current to 10µA, and the battery drain current to less than 2µA even with power applied to both inputs.

Other features include automatic recharge, undervoltage lockout, charge status output, power present status output to indicate the presence of wall adapter or USB power and high power/low power mode (C/5) for USB compatible applications.

TYPICAL APPLICATION

Dual Input Battery Charger for Single-Cell Li-Ion
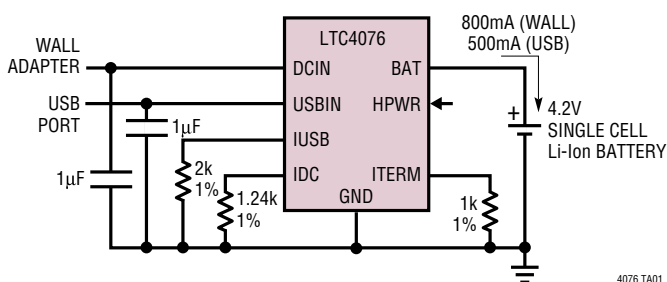
Complete Charge Cycle (1100mAh Battery)

USBIN = 5V
T_A = 25°C
R_{IDC} = 1.24k
R_{IUSB} = 2k
HPWR = 5V
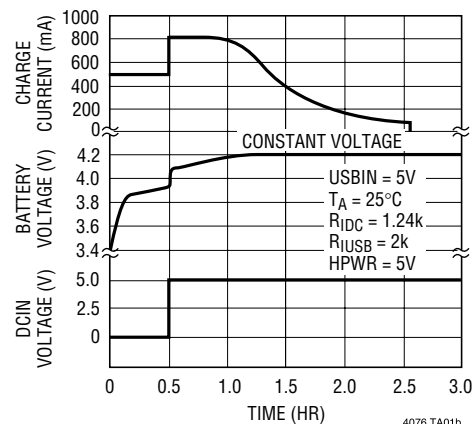
ABSOLUTE MAXIMUM RATINGS

(Notes 1, 7)

Input Supply Voltage (DCIN, USBIN) ....−0.3V to 10V
$\overline{EN}$, $\overline{CHRG}$, $\overline{PWR}$, HPWR ....−0.3V to 10V
BAT, IDC, IUSB, ITERM ....−0.3V to 7V
DCIN Pin Current (Note 6) 1A
USBIN Pin Current (Note 6) 700mA
BAT Pin Current (Note 6) 1A
BAT Short-Circuit Duration...........................Continuous
Maximum Junction Temperature ....125°C
Operating Temperature Range (Note 2) .. −40°C to 85°C
Storage Temperature Range.................. −65°C to 125°C

PACKAGE/ORDER INFORMATION

TOP VIEW

USBIN	1	10	DCIN
IUSB	2	9	BAT
ITERM	3	8	IDC
$\overline{PWR}$	4	7	HPWR
$\overline{CHRG}$	5	6	$\overline{EN}$

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DD PACKAGE
10-LEAD (3mm × 3mm) PLASTIC DFN

T_{JMAX} = 125°C, θ_{JA} = 40°C/W (NOTE 3)
EXPOSED PAD (PIN 11) IS GND, MUST BE SOLDERED TO PCB

ORDER PART NUMBER	DD PART MARKING
LTC4076EDD	LBWC

Order Options Tape and Reel: Add #TR
Lead Free: Add #PBF   Lead Free Tape and Reel: Add #TRPBF
Lead Free Part Marking: http://www.linear.com/leadfree/

Consult LTC Marketing for parts specified with wider operating temperature ranges.

ELECTRICAL CHARACTERISTICS
The ● denotes the specifications which apply over the full operating temperature range, otherwise specifications are at T_A = 25°C. V_{DCIN} = 5V, V_{USBIN} = 5V, HPWR = 5V unless otherwise noted.

SYMBOL	PARAMETER	CONDITIONS		MIN	TYP	MAX	UNITS
V_{DCIN}	Supply Voltage		●	4.3		8	V
V_{USBIN}	Supply Voltage		●	4.3		8	V
I_{DCIN}	DCIN Supply Current	Charge Mode (Note 4), R_{IDC} = 10k	●		250	800	µA
		Standby Mode; Charge Terminated	●		50	100	µA
		Shutdown Mode ($\overline{EN}$ = 5V)			20	40	µA
I_{USBIN}	USBIN Supply Current	Charge Mode (Note 5), R_{IUSB} = 10k, V_{DCIN} = 0V	●		250	800	µA
		Standby Mode; Charge Terminated, V_{DCIN} = 0V	●		50	100	µA
		Shutdown (V_{DCIN} = 0V, $\overline{EN}$ = 5V)			18	36	µA
		V_{DCIN} > V_{USBIN}			10	20	µA
V_{FLOAT}	Regulated Output (Float) Voltage	I_{BAT} = 1mA (Note 7)		4.175	4.2	4.225	V
		I_{BAT} = 1mA, 0°C < T_A < 85°C, 4.3V < V_{CC} < 8V		4.158	4.2	4.242	V
I_{BAT}	BAT Pin Current	R_{IDC} = 1.25k, Constant-Current Mode	●	760	800	840	mA
		R_{IUSB} = 2.1k, Constant-Current Mode	●	450	476	500	mA
		R_{IUSB} = 2.1k, HPWR = 0V	●	84	95	105	mA
		R_{IDC} = 10k or R_{IUSB} = 10k	●	92	100	108	mA
		Standby Mode, Charge Terminated			−3	−6	µA
		Shutdown Mode (Charger Disabled)			−1	−2	µA
		Sleep Mode (V_{DCIN} = 0V, V_{USBIN} = 0V)			±1	±2	µA
V_{IDC}	IDC Pin Regulated Voltage	Constant-Current Mode		0.95	1	1.05	V
V_{IUSB}	IUSB Pin Regulated Voltage	Constant-Current Mode		0.95	1	1.05	V
$I_{TERMINATE}$	Charge Current Termination Threshold	R_{ITERM} = 1k	●	90	100	110	mA
		R_{ITERM} = 2k	●	45	50	55	mA
		R_{ITERM} = 10k	●	8	10	12	mA
		R_{ITERM} = 20k	●	3.5	5	6.5	mA

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ELECTRICAL CHARACTERISTICS

The ● denotes the specifications which apply over the full operating temperature range, otherwise specifications are at T_A = 25°C. V_{DCIN} = 5V, V_{USBIN} = 5V, HPWR = 5V unless otherwise noted.

SYMBOL	PARAMETER	CONDITIONS		MIN	TYP	MAX	UNITS
I_{TRIKL}	Trickle Charge Current	$V_{BAT} < V_{TRIKL}$; R_{IDC} = 1.25k		60	80	100	mA
		$V_{BAT} < V_{TRIKL}$; R_{IUSB} = 2.1k		30	47.5	65	mA
V_{TRIKL}	Trickle Charge Threshold Voltage	V_{BAT} Rising		2.8	2.9	3	V
		Hysteresis			100		mV
V_{UVDC}	DCIN Undervoltage Lockout Voltage	From Low to High		4	4.15	4.3	V
		Hysteresis			200		mV
V_{UVUSB}	USBIN Undervoltage Lockout Voltage	From Low to High		3.8	3.95	4.1	V
		Hysteresis			200		mV
V_{ASD-DC}	$V_{DCIN} - V_{BAT}$ Lockout Threshold	V_{DCIN} from Low to High, V_{BAT} = 4.2V		140	180	220	mV
		V_{DCIN} from High to Low, V_{BAT} = 4.2V		20	50	80	mV
$V_{ASD-USB}$	$V_{USBIN} - V_{BAT}$ Lockout Threshold	V_{USBIN} from Low to High		140	180	220	mV
		V_{USBIN} from High to Low		20	50	80	mV
$V_{\overline{EN}}$	$\overline{EN}$ Input Threshold Voltage			0.4	0.7	1	V
$R_{\overline{EN}}$	$\overline{EN}$ Pulldown Resistance		●	1	2	5	MΩ
V_{HPWR}	HPWR Input Threshold Voltage			0.4	0.7	1	V
R_{HPWR}	HPWR Pulldown Resistance		●	1	2	5	MΩ
$V_{\overline{CHRG}}$	$\overline{CHRG}$ Output Low Voltage	$I_{\overline{CHRG}}$ = 5mA			0.35	0.6	V
$V_{\overline{PWR}}$	$\overline{PWR}$ Output Low Voltage	$I_{\overline{PWR}}$ = 5mA			0.35	0.6	V
ΔV_{RECHRG}	Recharge Battery Threshold Voltage	$V_{FLOAT} - V_{RECHRG}$, 0°C < T_A < 85°C		65	100	135	mV
t_{RECHRG}	Recharge Comparator Filter Time	V_{BAT} from High to Low		3	6	10	ms
$t_{TERMINATE}$	Termination Comparator Filter Time	I_{BAT} Drops Below Termination Threshold		0.8	1.5	2.2	ms
t_{SS}	Soft-Start Time	I_{BAT} = 10% to 90% Full-Scale		175	250	325	µs
R_{ON-DC}	Power FET "ON" Resistance (Between DCIN and BAT)				400		mΩ
R_{ON-USB}	Power FET "ON" Resistance (Between USBIN and BAT)				550		mΩ
T_{LIM}	Junction Temperature in Constant-Temperature Mode				105		°C

Note 1: Stresses beyond those listed under Absolute Maximum Ratings may cause permanent damage to the device. Exposure to any Absolute Maximum Rating condition for extended periods may affect device reliability and lifetime.

Note 2: The LTC4076E is guaranteed to meet the performance specifications from 0°C to 85°C. Specifications over the –40°C to 85°C operating temperature range are assured by design, characterization and correlation with statistical process controls.

Note 3: Failure to correctly solder the exposed backside of the package to the PC board will result in a thermal resistance much higher than 40°C/W. See Thermal Considerations.

Note 4: Supply current includes IDC and ITERM pin current (approximately 100µA each) but does not include any current delivered to the battery through the BAT pin.

**Note 5:** Supply current includes IUSB and ITERM pin current (approximately 100µA each) but does not include any current delivered to the battery through the BAT pin.

Note 6: Guaranteed by long term current density limitations.
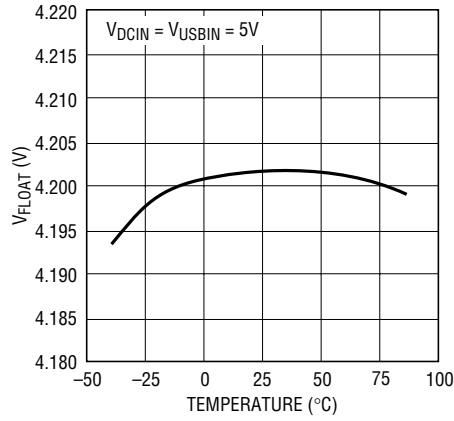
Note 7: V_{CC} is greater of DCIN or USBIN

TYPICAL PERFORMANCE CHARACTERISTICS
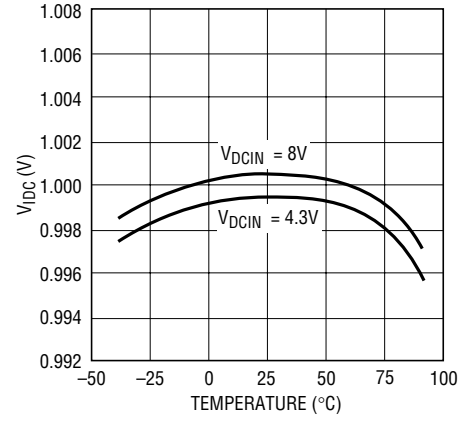
Regulated Output (Float) Voltage vs Charge Current

$V_{DCIN} = V_{USBIN} = 5V$

$R_{IDC} = R_{IUSB} = 2k$ $R_{IDC} = 1.25k$
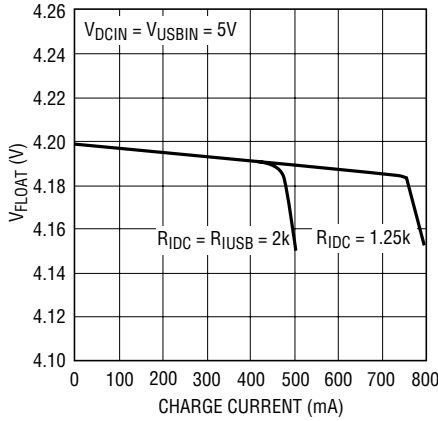
4076 G01

Regulated Output (Float) Voltage vs Temperature

$V_{DCIN} = V_{USBIN} = 5V$

4076 G02

IDC Pin Voltage vs Temperature (Constant-Current Mode)

$V_{DCIN} = 8V$

$V_{DCIN} = 4.3V$

4076 G03

IUSB Pin Voltage vs Temperature (Constant-Current Mode)

HPWR = 5V

$V_{USBIN} = 8V$

$V_{USBIN} = 4.3V$
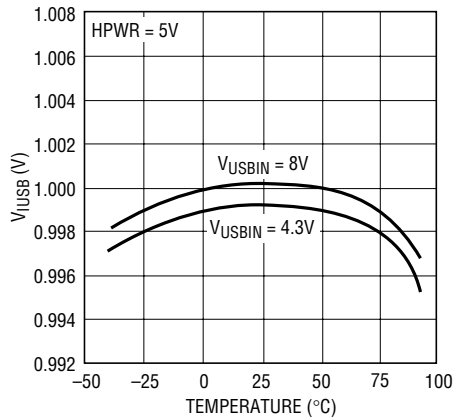
4076 G04

IUSB Pin Voltage vs Temperature (Constant-Current Mode)

HPWR = 0V

$V_{USBIN} = 8V$

$V_{USBIN} = 4.3V$
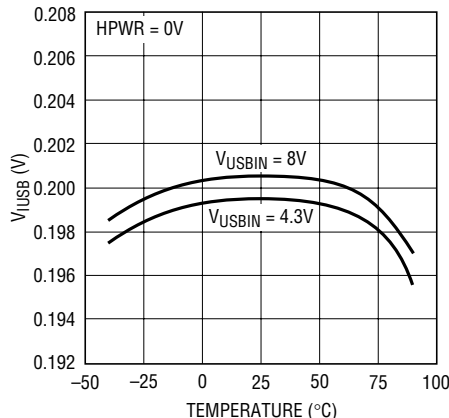
4076 G24

Charge Current vs IDC Pin Voltage

$V_{DCIN} = 5V$

$R_{IDC} = 1.25k$

$R_{IDC} = 2k$

$R_{IDC} = 10k$
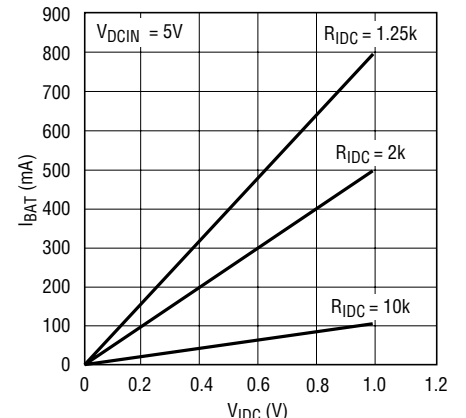
4076 G05

Charge Current vs IUSB Pin Voltage

$V_{USBIN} = 5V$ HPWR = 5V

$R_{IUSB} = 1.25k$

$R_{IUSB} = 2k$

$R_{IUSB} = 10k$
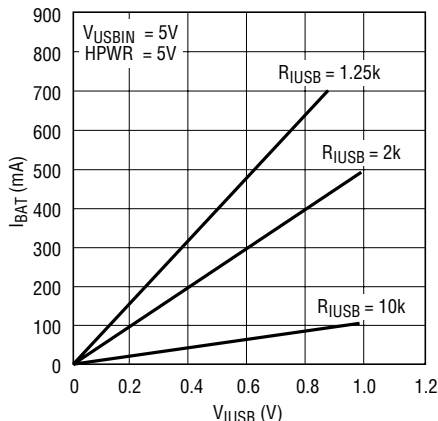
4076 G06

Charge Current vs IUSB Pin Voltage

$V_{USBIN} = 5V$ HPWR = 0V

$R_{IUSB} = 1k\Omega$

$R_{IUSB} = 2k\Omega$

$R_{IUSB} = 4k\Omega$

4076 G25

$\overline{PWR}$ Pin I-V Curve

$V_{DCIN} = V_{USBIN} = 5V$

$T_A = -40°C$

$T_A = 25°C$

$T_A = 90°C$

4076 G07

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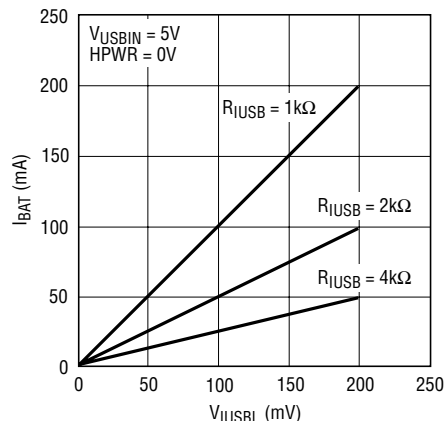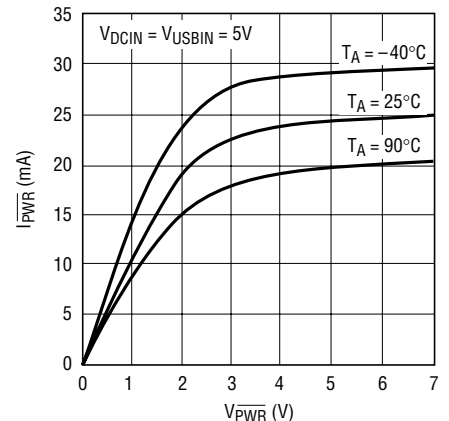
TYPICAL PERFORMANCE CHARACTERISTICS

$\overline{CHRG}$ Pin I-V Curve

$V_{DCIN} = V_{USBIN} = 5V$

$T_A = -40°C$
$T_A = 25°C$
$T_A = 90°C$

$I_{\overline{CHRG}}$ (mA)

$V_{\overline{CHRG}}$ (V)
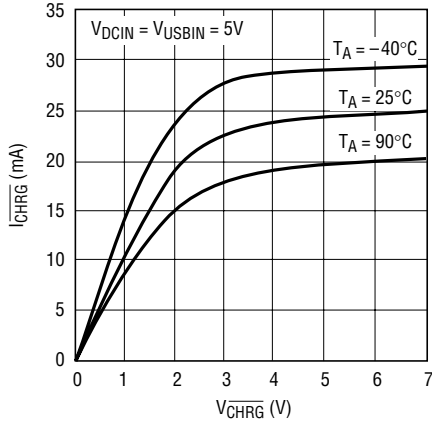
4076 G08

Charge Current vs Ambient Temperature

ONSET OF THERMAL REGULATION

$R_{IDC} = 1.25k$

$R_{IDC} = R_{IUSB} = 2k$

HPWR = 5V
$V_{DCIN} = V_{USBIN} = 5V$
$V_{BAT} = 4V$
$\theta_{JA} = 40°C/W$

I_{BAT} (mA)
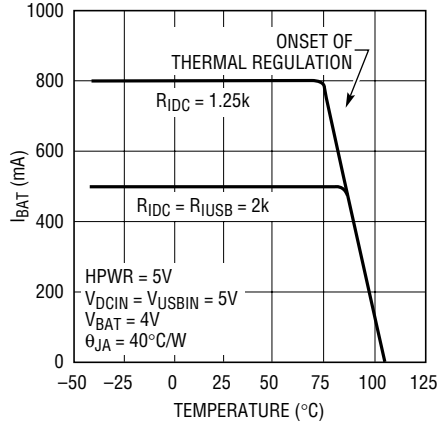
TEMPERATURE (°C)

4076 G09

Charge Current vs Supply Voltage

ONSET OF THERMAL REGULATION

$R_{IDC} = 1.25k$
$V_{BAT} = 4V$
$\theta_{JA} = 35°C/W$

I_{BAT} (mA)

V_{DCIN} (V)
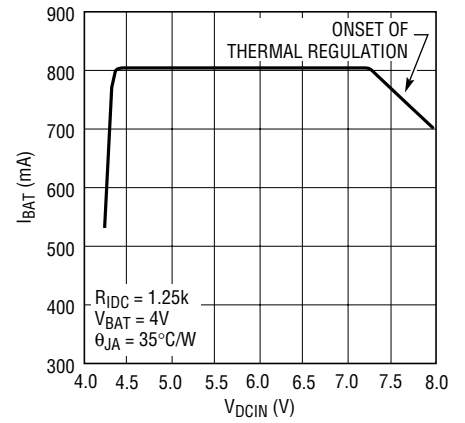
4076 G10

Charge Current vs Battery Voltage

$V_{DCIN} = V_{USBIN} = 5V$
$\theta_{JA} = 40°C/W$
$R_{IDC} = 1.25k$

I_{BAT} (mA)

V_{BAT} (V)
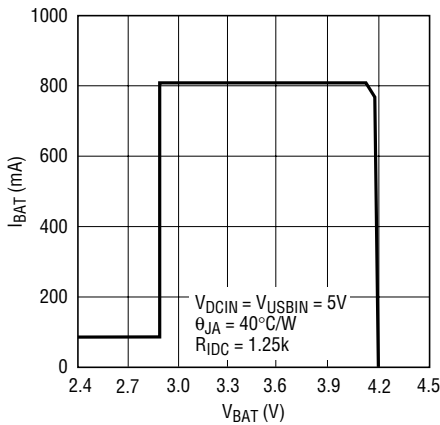
4076 G11

DCIN Power FET "On" Resistance vs Temperature

$V_{BAT} = 4V$
$I_{BAT} = 200mA$

$R_{DS(ON)}$ (mΩ)
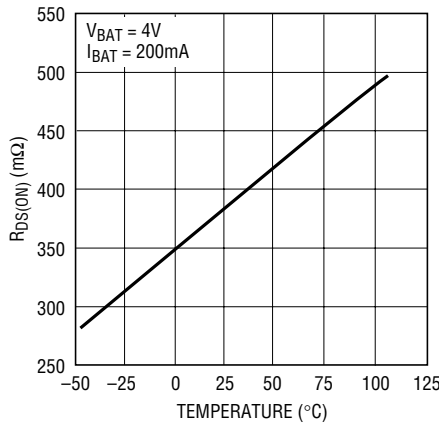
TEMPERATURE (°C)

4076 G12

USBIN Power FET "On" Resistance vs Temperature

$V_{BAT} = 4V$
$I_{BAT} = 200mA$
HPWR = 5V

$R_{DS(ON)}$ (mΩ)
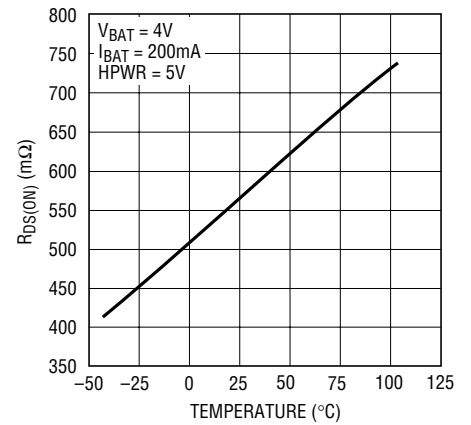
TEMPERATURE (°C)

4076 G13

$\overline{EN}$ Pin Threshold (Rising) vs Temperature

$V_{DCIN} = V_{USBIN} = 5V$

$V_{\overline{EN}}$ (mV)
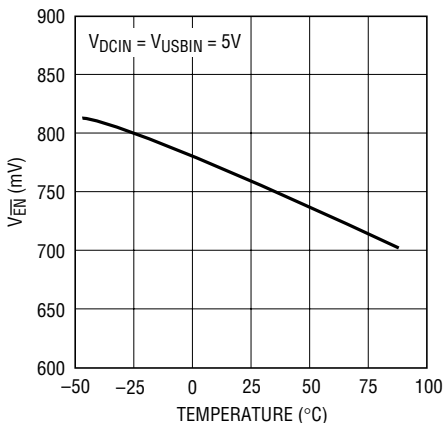
TEMPERATURE (°C)

4076 G14

HPWR Pin Threshold (Rising) vs Temperature

$V_{DCIN} = V_{USBIN} = 5V$

V_{HPWR} (mV)
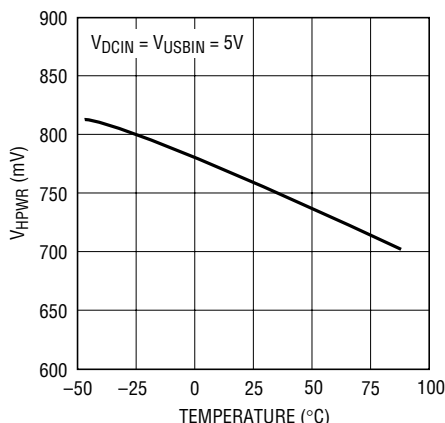
TEMPERATURE (°C)

4076 G15

DCIN Shutdown Current vs Temperature

$V_{DCIN} = 8V$

$V_{DCIN} = 5V$

$V_{DCIN} = 4.3V$

$\overline{EN} = 5V$

I_{DCIN} (μA)
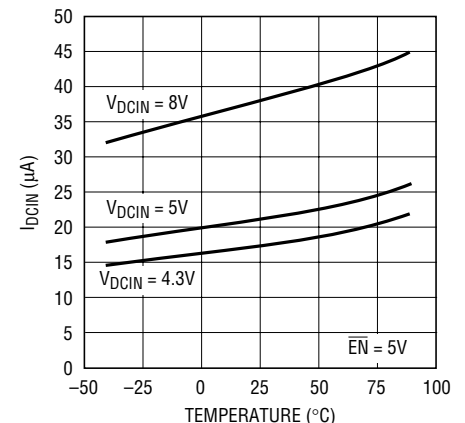
TEMPERATURE (°C)

4076 G16

TYPICAL PERFORMANCE CHARACTERISTICS

USBIN Shutdown Current vs Temperature

4076 G17

$\overline{EN}$ Pin Pulldown Resistance vs Temperature

4076 G18

HPWR Pin Pulldown Resistance vs Temperature

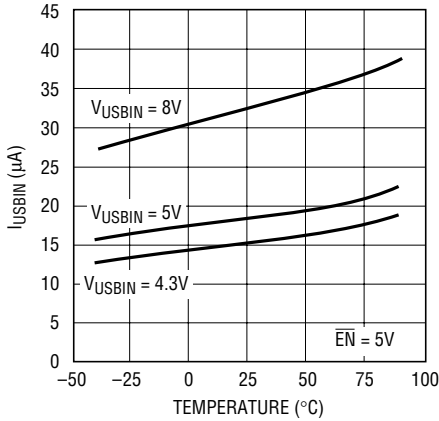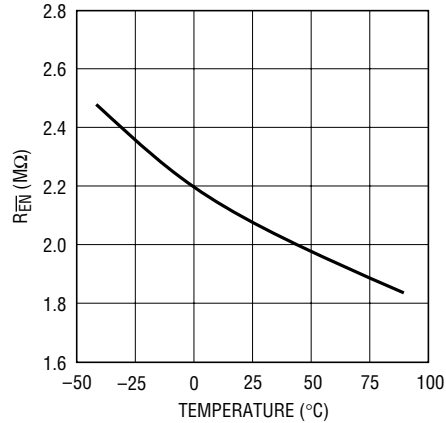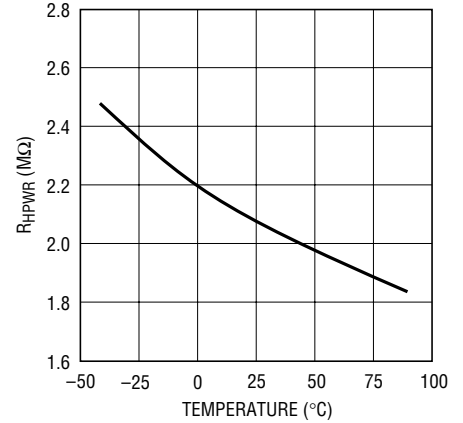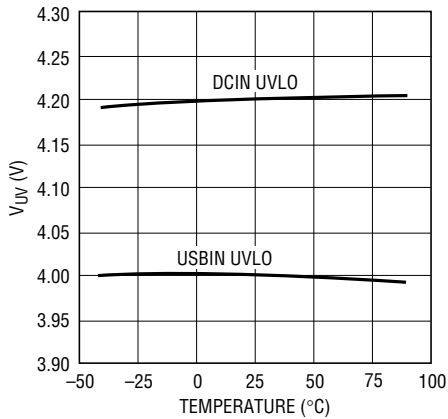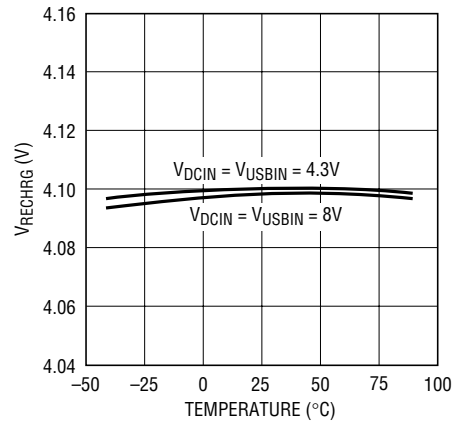

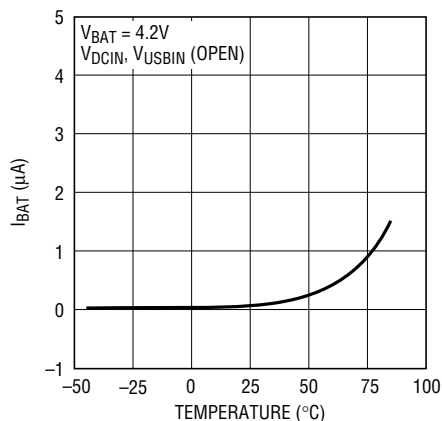4076 G19

Undervoltage Lockout Threshold vs Temperature

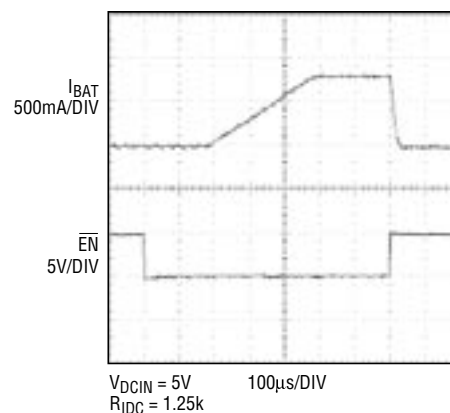

4076 G20

Recharge Threshold Voltage vs Temperature

4076 G21

Battery Drain Current vs Temperature

4076 G22

Charge Current at Turn-On and Turn-Off

4076 G23

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PIN FUNCTIONS

USBIN (Pin 1): USB Input Supply Pin. Provides power to the battery charger. The maximum supply current is 650mA. This pin should be bypassed with a 1µF capacitor.

IUSB (Pin 2): Charge Current Program for USB Power. The charge current is set by connecting a resistor, R_{IUSB}, to ground. When charging in constant-current mode, this pin servos to 1V. The voltage on this pin can be used to measure the battery current delivered from the USB input using the following formula:

$$I_{BAT} = \frac{V_{IUSB}}{R_{IUSB}} \cdot 1000 \ (HPWR = HIGH)$$

$$I_{BAT} = \frac{V_{IUSB}}{R_{IUSB}} \cdot 200 \ (HPWR = LOW)$$

ITERM (Pin 3): Termination Current Threshold Program. The termination current threshold, $I_{TERMINATE}$, is set by connecting a resistor, R_{ITERM}, to ground. $I_{TERMINATE}$ is set by the following formula:

$$I_{TERMINATE} = \frac{100V}{R_{ITERM}}$$

When the battery current, I_{BAT}, falls below the termination threshold, charging stops and the $\overline{CHRG}$ output becomes high impedance.

This pin is internally clamped to approximately 1.5V. Driving this pin to voltages beyond the clamp voltage should be avoided.

$\overline{PWR}$ (Pin 4): Open-Drain Power Supply Status Output. When the DCIN or USBIN pin voltage is sufficient to begin charging (i.e. when the supply is greater than the under-voltage lockout threshold and at least 180mV above the battery terminal), the $\overline{PWR}$ pin is pulled low by an internal N-channel MOSFET. Otherwise $\overline{PWR}$ is high impedance. This output is capable of sinking up to 10mA, making it suitable for driving an LED.

$\overline{CHRG}$ (Pin 5): Open-Drain Charge Status Output. When the LTC4076 is charging, the $\overline{CHRG}$ pin is pulled low by an internal N-channel MOSFET. When the charge cycle is completed, $\overline{CHRG}$ becomes high impedance. This output is capable of sinking up to 10mA, making it suitable for driving an LED.

$\overline{EN}$ (Pin 6): Charge Enable Input. A logic low on this pin enables the charger. If left floating, an internal 2MΩ pull-down resistor defaults the LTC4076 to charge mode . Pull this pin high for shutdown.

HPWR (Pin 7): HPWR Enable Input. Used to control the amount of current drawn from the USB port. A logic high on the HPWR pin sets the charge current to 100% of the current programmed by the IUSB pin. A logic low on the HPWR pin sets the charge current to 20% of the current programmed by the IUSB pin. An internal 2MΩ pull-down resistor defaults the HPWR pin to its low current state.

IDC (Pin 8): Charge Current Program for Wall Adapter Power. The charge current is set by connecting a resistor, R_{IDC}, to ground. When charging in constant-current mode, this pin servos to 1V. The voltage on this pin can be used to measure the battery current delivered from the DC input using the following formula:

$$I_{BAT} = \frac{V_{IDC}}{R_{IDC}} \cdot 1000$$

BAT (Pin 9): Charger Output. This pin provides charge current to the battery and regulates the final float voltage to 4.2V.

DCIN (Pin 10): Wall Adapter Input Supply Pin. Provides power to the battery charger. The maximum supply current is 950mA. This should be bypassed with a 1µF capacitor.

Exposed Pad (Pin 11): GND. The exposed backside of the package is ground and must be soldered to PC board ground for electrical connection and maximum heat transfer.

LTC4076

BLOCK DIAGRAM

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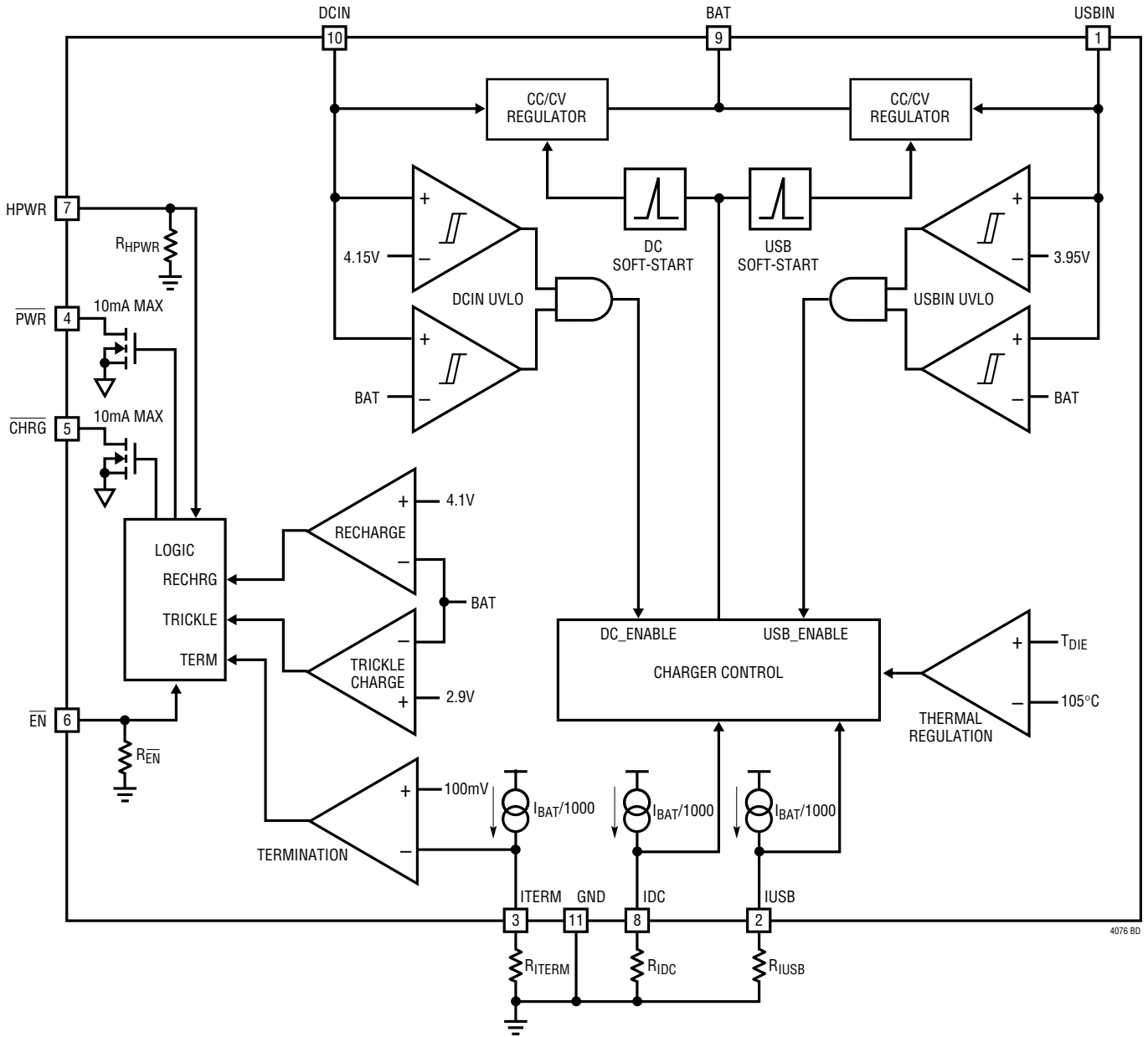
OPERATION

The LTC4076 is designed to efficiently manage charging of a single-cell lithium-ion battery from two separate power sources: a wall adapter and USB power bus. Using the constant-current/constant-voltage algorithm, the charger can deliver up to 950mA of charge current from the wall adapter supply or up to 650mA of charge current from the USB supply with a final float voltage accuracy of ±0.6%. The LTC4076 has two internal P-channel power MOSFETs and thermal regulation circuitry. No blocking diodes or external sense resistors are required.

Power Source Selection

The LTC4076 can charge a battery from either the wall adapter input or the USB port input. The LTC4076 automatically senses the presence of voltage at each input. If both power sources are present, the LTC4076 defaults to the wall adapter source provided sufficient power is present at the DCIN input. "Sufficient power" is defined as:

- Supply voltage is greater than the UVLO threshold.

- Supply voltage is greater than the battery voltage by 50mV (180mV rising, 50mV falling).

The open drain power status output ($\overline{PWR}$) indicates that sufficient power is available. Table 1 describes the behavior of this status output.

Table 1. Power Source Selection

	$V_{USBIN} > 3.95V$ and $V_{USBIN} > BAT + 50mV$	$V_{USBIN} < 3.95V$ or $V_{USBIN} < BAT + 50mV$
$V_{DCIN} > 4.15V$ and $V_{DCIN} > BAT + 50mV$	Device powered from wall adapter source; USBIN current < 25µA $\overline{PWR}$: LOW	Device powered from wall adapter source $\overline{PWR}$: LOW
$V_{DCIN} < 4.15V$ or $V_{DCIN} < BAT + 50mV$	Device powered from USB source; $\overline{PWR}$: LOW	No charging $\overline{PWR}$: Hi-Z

Programming and Monitoring Charge Current

The charge current delivered to the battery from the wall adapter supply is programmed using a single resistor from the IDC pin to ground.

$$R_{IDC} = \frac{1000V}{I_{CHRG(DC)}}, \; I_{CHRG(DC)} = \frac{1000V}{R_{IDC}}$$

Similarly, the charge current from the USB supply is programmed using a single resistor from the IUSB pin to ground. Setting HPWR pin to its high state will select 100% of the programmed charge current, while setting HPWR to its low state will select 20% of the programmed charge current.

$$R_{IUSB} = \frac{1000V}{I_{CHRG(USB)}} \; (HPWR = HIGH)$$

$$I_{CHRG(USB)} = \frac{1000V}{R_{IUSB}} \; (HPWR = HIGH)$$

$$I_{CHRG(USB)} = \frac{200V}{R_{IUSB}} \; (HPWR = LOW)$$

Charge current out of the BAT pin can be determined at any time by monitoring the IDC or IUSB pin voltage and using the following equations:

$$I_{BAT} = \frac{V_{IDC}}{R_{IDC}} \bullet 1000, \, (charging \, from \, wall \, adapter)$$

$$I_{BAT} = \frac{V_{IUSB}}{R_{IUSB}} \bullet 1000, \, (charging \, from \, USB \, supply, \\ HPWR = HIGH)$$

$$I_{BAT} = \frac{V_{IUSB}}{R_{IUSB}} \bullet 200, \, (charging \, from \, USB \, supply, \\ HPWR = LOW)$$

Programming Charge Termination

The charge cycle terminates when the charge current falls below the programmed termination threshold during constant-voltage mode. This threshold is set by connecting an external resistor, R_{ITERM}, from the ITERM pin to ground. The charge termination current threshold ($I_{TERMINATE}$) is set by the following equation:

$$R_{ITERM} = \frac{100V}{I_{TERMINATE}}, I_{TERMINATE} = \frac{100V}{R_{ITERM}}$$

OPERATION

The termination condition is detected by using an internal filtered comparator to monitor the ITERM pin. When the ITERM pin voltage drops below 100mV* for longer than $t_{TERMINATE}$ (typically 1.5ms), the charge cycle terminates, charge current latches off and the LTC4076 enters standby mode.

When charging, transient loads on the BAT pin can cause the ITERM pin to fall below 100mV for short periods of time before the DC charge current has dropped below the programmed termination current. The 1.5ms filter time ($t_{TERMINATE}$) on the termination comparator ensures that transient loads of this nature do not result in premature charge cycle termination. Once the *average* charge current drops below the programmed termination threshold, the LTC4076 terminates the charge cycle and ceases to provide any current out of the BAT pin. In this state, any load on the BAT pin must be supplied by the battery.

Low-Battery Charge Conditioning (Trickle Charge)

This feature ensures that deeply discharged batteries are gradually charged before applying full charge current . If the BAT pin voltage is below 2.9V, the LTC4076 supplies 1/10th of the full charge current to the battery until the BAT pin rises above 2.9V. For example, if the charger is programmed to charge at 800mA from the wall adapter input and 500mA from the USB input, the charge current during trickle charge mode would be 80mA and 50mA, respectively.

Automatic Recharge

In standby mode, the charger sits idle and monitors the battery voltage using a comparator with a 6ms filter time (t_{RECHRG}). A charge cycle automatically restarts when the battery voltage falls below 4.1V (which corresponds to approximately 80%-90% battery capacity). This ensures that the battery is kept at, or near, a fully charged condition and eliminates the need for periodic charge cycle initiations.

If the battery is removed from the charger, a sawtooth waveform of approximately 100mV appears at the battery output. This is caused by the repeated cycling between termination and recharge events. This cycling results in pulsing at the $\overline{CHRG}$ output; an LED connected to this pin will exhibit a blinking pattern, indicating to the user that a battery is not present. The frequency of the sawtooth is dependent on the amount of output capacitance.

Manual Shutdown

The $\overline{EN}$ pin has a 2MΩ pulldown resistor to GND. A logic low enables the charger and logic high disables it (the pulldown defaults the charger to the charging state).

The DCIN input draws 20µA when the charger is in shutdown. The USBIN input draws 18µA during shutdown if no power is applied to DCIN, but draws only 10µA when $V_{DCIN} > V_{USBIN}$.

Charge Current Soft-Start and Soft-Stop

The LTC4076 includes a soft-start circuit to minimize the inrush current at the start of a charge cycle. When a charge cycle is initiated, the charge current ramps from zero to full-scale current over a period of 250µs. Likewise, internal circuitry slowly ramps the charge current from full-scale to zero in a period of approximately 30µs when the charger shuts down or self terminates. This minimizes the transient current load on the power supply during start-up and shut-off.

Status Indicators

The charge status output ($\overline{CHRG}$) has two states: pull-down and high impedance. The pull-down state indicates that the LTC4076 is in a charge cycle. Once the charge cycle has terminated or the LTC4076 is disabled, the pin state becomes high impedance. The pull-down state is capable of sinking up to 10mA.

*Any external sources that hold the ITERM pin above 100mV will prevent the LTC4076 from terminating a charge cycle.

OPERATION

The power supply status output ($\overline{PWR}$) has two states: pull-down and high impedance. The pull-down state indicates that power is present at either $\overline{DCIN}$ or USBIN. If no power is applied at either pin, the $\overline{PWR}$ pin is high impedance, indicating that the LTC4076 lacks sufficient power to charge the battery. The pull-down state is capable of sinking up to 10mA.

Thermal Limiting

An internal thermal feedback loop reduces the programmed charge current if the die temperature attempts to rise above a preset value of approximately 105°C. This feature protects the LTC4076 from excessive temperature and allows the user to push the limits of the power handling capability of a given circuit board without risk of damaging the device. The charge current can be set according to typical (not worst-case) ambient temperature with the assurance that the charger will automatically reduce the current in worst-case conditions. DFN power considerations are discussed further in the Applications Information section.
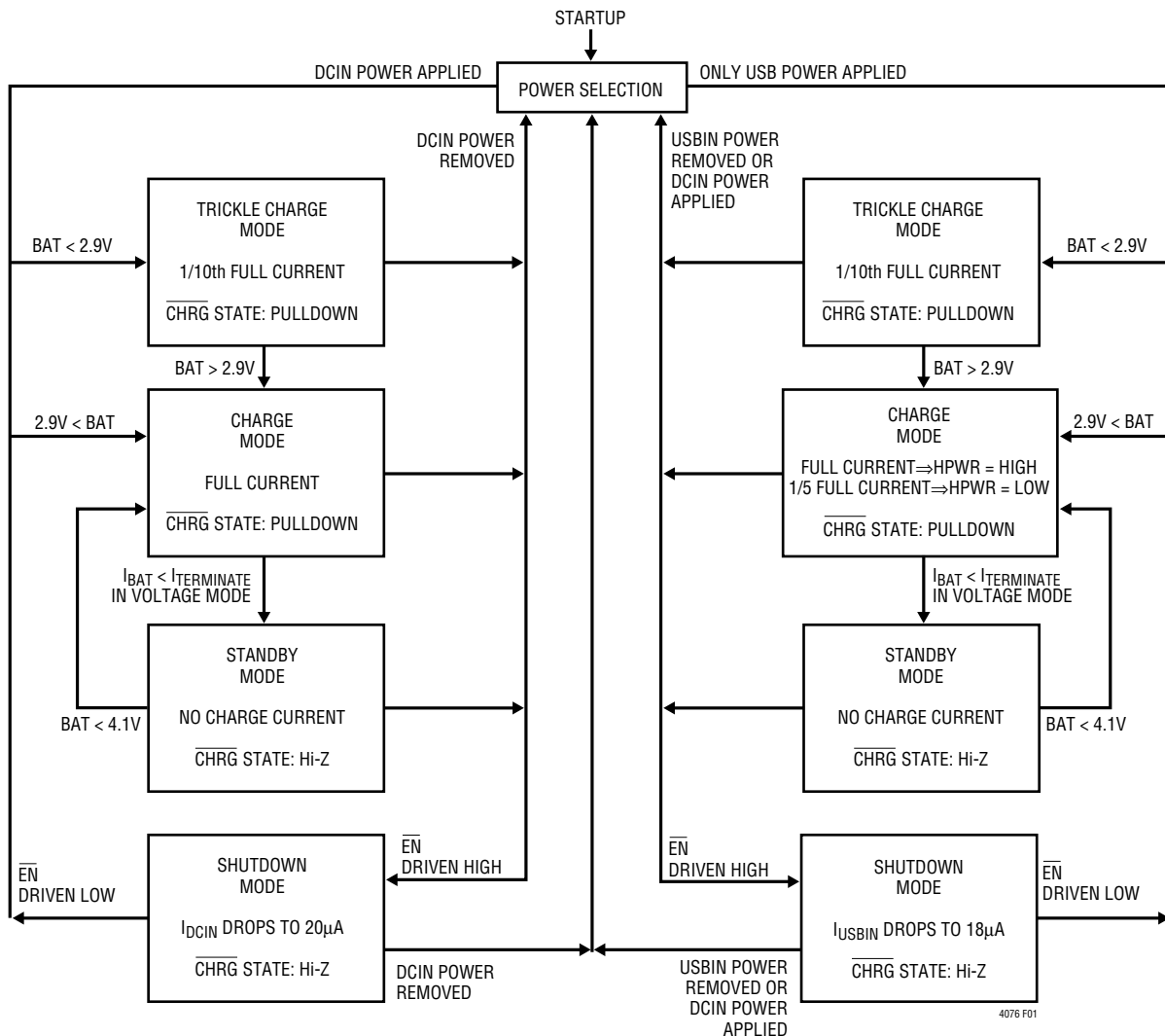

Figure 1. LTC4076 State Diagram of a Charge Cycle

APPLICATIONS INFORMATION

Using a Single Charge Current Program Resistor

In applications where the programmed wall adapter charge current and USB charge current are the same, a single program resistor can be used to set both charge currents. Figure 2 shows a charger circuit that uses one charge current program resistor. In this circuit, one resistor programs the same charge current for each input supply.

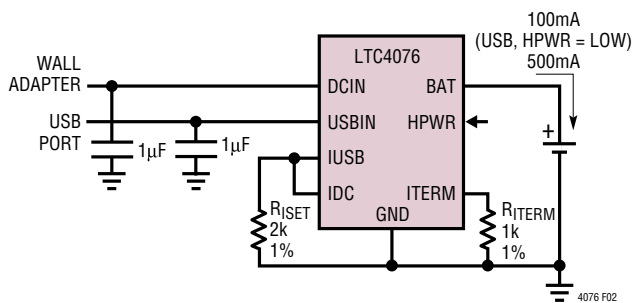$$I_{CHRG(DC)} = I_{CHRG(USB)} = \frac{1000V}{R_{ISET}}$$

Figure 2. Dual Input Charger Circuit. The Wall Adapter Charge Current and USB Charge Current are Both Programmed to be 500mA

The LTC4076 can also program the wall adapter charge current and USB charge current independently using two program resistors, R_{IDC} and R_{IUSB}. Figure 3 shows a charger circuit that sets the wall adapter charge current to 800mA and the USB charge current to 500mA.

Stability Considerations

The constant-voltage mode feedback loop is stable without any compensation provided a battery is connected to the charger output. However, a 1µF capacitor with a 1Ω series resistor is recommended at the BAT pin to keep the ripple voltage low when the battery is disconnected.

When the charger is in constant-current mode, the charge current program pin (IDC or IUSB) is in the feedback loop, not the battery. The constant-current mode stability is affected by the impedance at the charge current program pin. With no additional capacitance on this pin, the charger is stable with program resistor values as high as 20k (I_{CHRG} = 50mA); however, additional capacitance on these nodes reduces the maximum allowed program resistor.
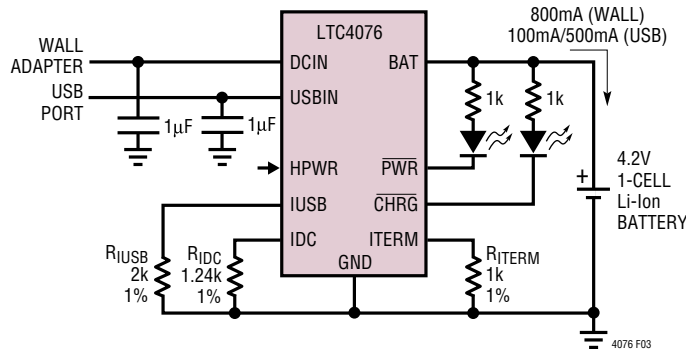

Figure 3. Full Featured Dual Input Charger Circuit

APPLICATIONS INFORMATION

Power Dissipation

When designing the battery charger circuit, it is not necessary to design for worst-case power dissipation scenarios because the LTC4076 automatically reduces the charge current during high power conditions. The conditions that cause the LTC4076 to reduce charge current through thermal feedback can be approximated by considering the power dissipated in the IC. Most of the power dissipation is generated from the internal MOSFET pass device. Thus, the power dissipation is calculated to be:

$$P_D = (V_{IN} - V_{BAT}) \bullet I_{BAT}$$

P_D is the power dissipated, V_{IN} is the input supply voltage (either DCIN or USBIN), V_{BAT} is the battery voltage and I_{BAT} is the charge current. The approximate ambient temperature at which the thermal feedback begins to protect the IC is:

$$T_A = 105°C - P_D \bullet \theta_{JA}$$
$$T_A = 105°C - (V_{IN} - V_{BAT}) \bullet I_{BAT} \bullet \theta_{JA}$$

Example: An LTC4076 operating from a 5V wall adapter (on the DCIN input) is programmed to supply 800mA full-scale current to a discharged Li-Ion battery with a voltage of 3.3V. Assuming θ_{JA} is 40°C/W (see Thermal Considerations), the ambient temperature at which the LTC4076 will begin to reduce the charge current is approximately:

$$T_A = 105°C - (5V - 3.3V) \bullet (800mA) \bullet 40°C/W$$
$$T_A = 105°C - 1.36W \bullet 40°C/W = 105°C - 54.4°C$$
$$T_A = 50.6°C$$

The LTC4076 can be used above 50.6°C ambient, but the charge current will be reduced from 800mA. The approximate current at a given ambient temperature can be approximated by:

$$I_{BAT} = \frac{105°C - T_A}{(V_{IN} - V_{BAT)} \bullet \theta_{JA}}$$

Using the previous example with an ambient temperature of 60°C, the charge current will be reduced to approximately:

$$I_{BAT} = \frac{105°C - 60°C}{(5V - 3.3V) \bullet 40°C/W} = \frac{45°C}{68°C/A}$$
$$I_{BAT} = 662mA$$

It is important to remember that LTC4076 applications do not need to be designed for worst-case thermal conditions, since the IC will automatically reduce power dissipation when the junction temperature reaches approximately 105°C.

Thermal Considerations

In order to deliver maximum charge current under all conditions, it is critical that the exposed metal pad on the backside of the LTC4076 package is properly soldered to the PC board ground. When correctly soldered to a 2500mm^2 double sided 1oz copper board, the LTC4076 has a thermal resistance of approximately 40°C/W. Failure to make thermal contact between the exposed pad on the backside of the package and the copper board will result in thermal resistances far greater than 40°C/W. As an example, a correctly soldered LTC4076 can deliver over 800mA to a battery from a 5V supply at room temperature. Without a good backside thermal connection, this number would drop to much less than 500mA.

APPLICATIONS INFORMATION

Protecting the USB Pin and Wall Adapter Input from Overvoltage Transients

Caution must be exercised when using ceramic capacitors to bypass the USBIN pin or the wall adapter inputs. High voltage transients can be generated when the USB or wall adapter is hot plugged. When power is supplied via the USB bus or wall adapter, the cable inductance along with the self resonant and high Q characteristics of ceramic capacitors can cause substantial ringing which could exceed the maximum voltage ratings and damage the LTC4076. Refer to Linear Technology Application Note 88, entitled "Ceramic Input Capacitors Can Cause Overvoltage Transients" for a detailed discussion of this problem.

Always use an oscilloscope to check the voltage waveforms at the USBIN and DCIN pins during USB and wall adapter hot-plug events to ensure that overvoltage transients have been adequately removed.

Reverse Polarity Input Voltage Protection

In some applications, protection from reverse polarity voltage on the input supply pins is desired. If the supply voltage is high enough, a series blocking diode can be used. In other cases where the voltage drop must be kept low, a P-channel MOSFET can be used (as shown in Figure 4).
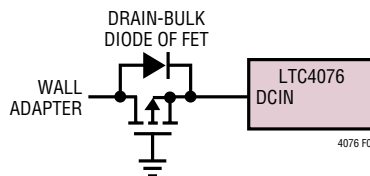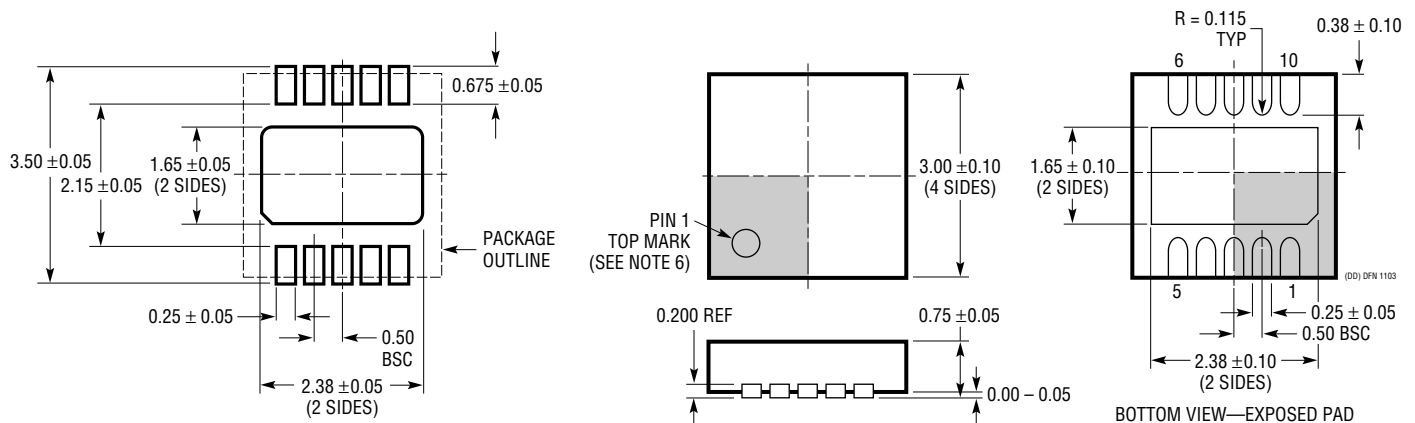

Figure 4. Low Loss Input Reverse Polarity Protection

PACKAGE DESCRIPTION

DD Package
10-Lead Plastic DFN (3mm × 3mm)
(Reference LTC DWG # 05-08-1699)

RECOMMENDED SOLDER PAD PITCH AND DIMENSIONS

NOTE:
1. DRAWING TO BE MADE A JEDEC PACKAGE OUTLINE M0-229 VARIATION OF (WEED-2).
   CHECK THE LTC WEBSITE DATA SHEET FOR CURRENT STATUS OF VARIATION ASSIGNMENT
2. DRAWING NOT TO SCALE
3. ALL DIMENSIONS ARE IN MILLIMETERS
4. DIMENSIONS OF EXPOSED PAD ON BOTTOM OF PACKAGE DO NOT INCLUDE
   MOLD FLASH. MOLD FLASH, IF PRESENT, SHALL NOT EXCEED 0.15mm ON ANY SIDE
5. EXPOSED PAD SHALL BE SOLDER PLATED
6. SHADED AREA IS ONLY A REFERENCE FOR PIN 1 LOCATION ON THE
   TOP AND BOTTOM OF PACKAGE